VII Semester B.E.

Electronics and Communication Engineering/ Electronics and Telecommunication Engineering

Course Code: EN701/ET701 **Title of the Course:** UHF and microwave

Course Scheme					Evaluation Scheme (Theory)				
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	3	4	5	3	10	10	80	100

Units	Contents	Hours
1	Microwave tubes : Causes of Failure of Conventional Tubes at Microwave Frequencies, Velocity Modulation and Electronic Efficiency In Single Cavity and Two Cavity Klystron.	10
2	Microwave tubes: Slow Wave Structure, Traveling Wave Tube and Backward Wave oscillator, Electron Motion In Parallel Plane Magnetron and Cylindrical Magnetron	09
3	Introduction to S – Matrix: Scattering Matrices and their Properties, Scattering Matrices of E plane Tee, H Plane Tee, Magic Tee, Directional Coupler and Transmission Lines.	09
4	Microwave Passive Device: Phase Shifter, Attenuator, Tees, Directional Coupler, Circulator, Isolators, Gyrators, Transmission Line Resonant Circuits.	09
5	Microwave Measurement And Solid State Devices: Low, Medium and High Power Measurement, Measurement of VSWR, Measurement of Impedance, Attenuation Measurement, Q Factor Measurement. GaAs Oscillator, PIN Diode, Parametric Amplifier, Maser, Microstrip Lines.	08
	Total	45

Text Books:

- 1. Foundations of microwave engineering: R.E. Collins. McGraw Hill
- 2. Microwave Device and Circuits: Samuel Y. Lio Prentice Hall of India

- 1. Radio Engg. Terman McGraw hill
- 2. Microwave Principles-Reich Wiley Eastern
- 3. Microwave engineering: R. Chatterjee, Prentice Hall of India
- 4. Microwave Engineering, Kulkarni, New Age International

Course Code: ET702

Title of the Course: Digital Communication

Course Scheme					Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total	
3	1	0	4	3	3	10	10	80	100	

Unit	Contents	Hours
1	Digital Communication System Basics Basic building blocks of Digital communications, analog versus digital communication, Advantages disadvantages of digital communications.	8
2	Digital Baseband Transmission Pulse code modulation, Signal to quantization ratio, non uniform quantization companding, BW calculations.	8
	Transmission of Analog Samples & Signal Detection in Noise	
3	Delta Modulation, Adaptive delta modulation, DPCM, ADCM, ADPCM, Matched Filter Receiver, Derivation of Its Impulse Response and Peak Pulse Signal to Noise Ratio. Correlator receiver, Decision Threshold and Error Probability For, Unipolar (ON-OFF) Signaling, ISI, Nyquist Criterion For Zero ISI & Raised Cosine Spectrum	10
	Digital Modulation Technique	
4	Gram-Schmidt Orthogonalization Procedure, Types of Digital Modulation, Wave forms for Amplitude, Frequency and Phase Shift Keying, Method of Generation and Detection of Coherent & Non-Coherent Binary ASK, FSK & PSK Differential Phase Shift Keying, Quadrature Modulation Techniques QPSK, Probability of Error and Comparison of Various Digital Modulation Techniques.	10
	Digital Multiplexing	
5	Fundamentals of Time Division Multiplexing, Electronic Commutator, Bit, Byte Interleaving T1 Carrier System, Synchronization and Signaling of T1, TDM, PCM Hierarchy, T1 to T4 PCM TDM System (DS1 to DS4 Signals)	9
	Total	45

- 1. Simon Haykin: Digital Communication, John Wiley / 4th Ed.
- 2. Bernard SKLAR: -Digital communication, Pearson education.
- 3. Lathi, B. P.:-Modern Digital & Analog Communication Systems, Oxford University Press.
- 4. Prokis J. J.: Digital Communications, McGraw Hill
- 5. Wayne Tomasi: Electronic Communication systems, Pearson Education, 5th edition

Course Code: ET703

Title of the Course: Opto-electronics devices and communication

Course Scheme					Evaluation Scheme (Theory)				
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	3	4	4	3	10	10	80	100

Units	Contents	Hours
1	Introduction to optical Fibers: Introduction to Step Index and Graded Index Fibers. Multimode Fibers, Propagation in Fibers Ray Mode, Numerical Aperture and Multipath Dispersion, Electromagnetic Wave Equation in SI and GI Fibers.	9
2	Signal Degradation : Manufacture of Fibers, Fiber Joints, Splices and Connectors. Attenuation, Material Dispersion, Waveguide Dispersion, Pulse Broadening, Mode Coupling.	9
3	Optical Sources and Coupling: Direct and Indirect Band Gap Materials, LED Structures , Light Source Materials, Quantum Efficiency and LED Power, Laser Diodes, Modes and Threshold Conditions, Rate Equations, External Quantum Efficiency, Resonant Frequencies and Temperature effects, Introduction to Quantum Laser, Fiber Amplifiers, Power Launching and Coupling, Lencing Schemes.	9
4	Optical Receivers: Pin and APD Diodes, Photo-Detectors, Noise SNR Detector Response Time, Avalanche Multiplication Noise, Comparison of Photo Detectors , Fundamental Receiver Operation , Preamplifiers, Receiver Configuration , Probability of Error Quantum Limit.	9
5	Digital Transmission System : Point to Point Links, WDM, Data Buses, Star and T-Coupler, NRZ, RZ and Block Codes. Measurement in Optical Fibers, Attenuation, Dispersion, Refractive Index Profile, Basic Concepts of SONET/SDH Network.	9
	Total	45

Text Books:

1. Optical Fiber Communication -G. Keiser McGraw Hill Publication

- 1. Optical Communication Principles and Practice J. senior, Prentice Hall of India
- 2. Optical Communication System J. Gower Prentice Hall of India.

Course Code: ET704 Title of the Course: Modern TV Engineering

Course Scheme				Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	0	4	4	3	10	10	80	100

Unit	Contents	Hours
	Fundamentals of television	
1	Television basics: Factors of TV systems, Composite video signal, Signal transmission and channel bandwidth, Colour TV systems, Colour fundamentals, Mixing of colours, Colour Perception, Chromaticity diagram.	9
	TV standards	
2	NTSC, PAL, SECAM systems, colour TV transmitter, high level, low level transmitters, colour TV receivers, remote control, antennas for transmission, TV alignment and TV pattern generation.	9
	Digital TV	
3	Introduction to Digital TV, Principle of Digital TV, Digital TV signals and parameters, Digital TV Transmitters, MAC signals, advanced MAC signal transmission, Digital TV receivers, Basic principles of Digital Video compression techniques, MPEG1, MPEG2, MPEG4, Video compression ITU-Standards(H.). Digital TV recording techniques.	9
	Satellite and cable television	
4	Geostationary satellites, Satellite communication systems, Cable signal sources, Cable signal processing and distribution, Cable signal converters.	9
	Advanced TV technologies	
5	HDTV standards and systems, HDTV transmitter and receiver/encoder, Digital TV satellite Systems, video on demand, CCTV, CATV, direct to home TV, set top box with recording facility, conditional access system (CAS),LCD TV System, Plasma TV Systems & LED technologies.	9
	Total	45

- Television and video Engineering, A. M. Dhake, TMH Publication.
 Video Simplified, Kelth jack, Penram International Publication.
 Audio Video Systems, R.G. Gupta, Technical Education.

- S. P. Bali, "Color TV Theory and Practice".
 Bernard Grobb, Charles E, "Basic TV and Video Sytems"
 R.R. Gulathi, "Modern television practice ".New age international

Course Code: ET705 Elective –I (i) **Title of the Course:** Elective –I: Nanotechnology

Course Scheme					Evaluation Scheme (Theory)				
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	0	4	4	3	10	10	80	100

Units	Contents	Hours
1	Introduction: Introduction to Nanotechnology: Fundamental science behind nanotechnology, tools for measuring nanostructures, tools to make nanostructures and imagine nanobehaviours.	9
2	Nano-CMOS Devices: Silicon Nanocrystal non volatile memories, Novel dielectric materials for future transistors, Nano-CMOS devices and applications. Scanning probe instrument, nanoscale lithography.	9
3	Nano particles and Nanotubes: Properties of Nano particles: Metal nanostructures and semiconducting nanoparticles, Carbon nanostructures: carbon molecules, clusters, nanotubes, properties of nanotubes-strength and elasticity, applications of carbon nanotubes.	9
4	Nanomachines and Nanodevices: Nanomachines and Nanodevices, NEMS and MEMS and their fabrication, molecular and super molecular switches. Lithography.	9
5	 Nanoelectronics: Introduction, the tools of manufacturing of micro and nano fabrication optical lithography, electron beam lithography, atomic lithography. Nano-Electronics for advanced computation and communication. Use of Nanotechnology in Electronics: Application of nano structures in electronics, sensors, optics, energy capture, transformation and storage. Application of nanotechnology in biomedical electronics. 	9
	Total	45

- 1. Anatoli Korkin, Jan Labanowski, Evgeni Gusev, Serge Luryi, "Nanotechnology for Electronic Materials and Devices"; Springer.
- 2. Mark Ratner, Daniel Ratner, "Nanotechnology: A Gentle introduction to a next big Idea"; Pearson Education.
- Gregory Timp, "Nanotechnology"; Springer-Verlag NY.
 Introduction to Nanotechnology –by Charles P. Poole Jr., Frank J. Owens John Wiley & Sons.

Course Code: ET 705 Elective-I (ii) Title of the Course: Elective –I: Wireless Sensor Network

Course Scheme					Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total	
3	1	0	4	4	3	10	10	80	100	

Units	Contents	Hours
1	Introduction and Overview of Wireless Sensor Networks, Commercial and Scientific Applications of Wireless Sensor Networks, Basic Wireless Sensor Technology, Sensor Taxonomy, wireless network environment, wireless network trends.	09
2	Sensors Network Protocols, Data dissemination and gathering, Routing Challenges and design issues in wireless sensor network, Routing strategies in WSN.	09
3	Radio technology primer, Available wireless technologies, Wireless Sensors Networks Protocols, Physical Layer, Fundamentals of Medium Access Control Protocols for Wireless Sensor Networks, MAC protocols for WSN, Case Study, IEEE 802.15 4LR WPAN, Standard case study.	09
4	Protocols, Transport Control Protocols for Wireless Sensors Networks, Traditional transport control protocol, transport protocol design issues, examples of existing transport control protocol, performance of TCP.	09
5	Middleware for Sensor Networks, WSN middleware principles, Middleware architecture, existing middleware.	09
	Total	45

Text Books:

- 1. Morgan Kaufmann F. Zhao and L. Guibas, 'Wireless Sensor Networks', a Francisco, 2004.
- 2. C. S. Raghavendra, Krishna M. Sivalingam, Taieb F. Znati, 'Wireless sensor networks', Edition: 2,

Published by Springer, 2004 ISBN 1402078838, 9781402078835

- 1. "Wireless Sensor Networks: Technology, Protocols, and Applications", Kazem Sohraby, Daniel Minoli, Taieb Znati, WIey Interscience Publication, 2007
- 2. "Computer Networks" ,Andrew Tanenbaum, 4th ed., Pearson Education,2007

Course Code: EN -704/ET705 Elective-I (iii) **Title of the Course:** Elective –I: VLSI Design

Course Scheme				Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	0	4	4	3	10	10	80	100

Unit	Contents	Hours
1	Introduction to CMOS technology: History of CMOS Technology, MOS transistors, MOS transistor switches, CMOS logic, Inverter, Combinational logic, NAND gate, NOR gate, Compound gates, Multiplexers, Memory-Latches and registers.	9
2	MOS transistor theory: NMOS enhancement Transistor, PMOS enhancement Transistor, Threshold Voltage and Body Effect, MOS Device Equations, Second order Effects, MOS Models, Small Signal AC Characteristics, CMOS Inverter DC Characteristics, Bn &Bp ratios, Noise margin, Static Load MOS Inverters, Transmission Gate and BI-CMOS Inverters.	9
3	CMOS processing technology: Silicon Semiconductor Technology, Wafer Processing, Oxidation, Epitaxy, Deposition, Ion Implantation, and Diffusion, Silicon Gate Process, Basic CMOS technology ,n- well process, p-well Process, Twin tub Process, SOI technology, Layout Design Rules, Latch up.	9
4	Circuit characterization and performance estimation: Resistance Estimation, Capacitance estimation, Inductance, Switching Characteristics, Analytical delay models, Fall time, Rise time, Delay time, CMOS Gate Transistor sizing, Power dissipation, Charge sharing, Yield.	9
5	CMOS circuit and logic design: CMOS Logic Gate Design, Basic Physical Design of Simple logic gates, inverter, NAND, NOR gates, Euler Graphs, CMOS Logic Structures, Clocking Strategies.	9
	Total	45

Text Books:

1. Principles of CMOSVLSI DESIGN-Neil Weste, Kamran Eshraghian- Pearson Education.

- 1. Introduction to VLSI Systems -Carver Mead, Lynn Conway -BS Publications.
- 2. Modern VLSI Design- Wayne Wolf- Pearson Education.
- 3. Basic VLSI Design- Douglas Pucknell, Kamran Eshraghian Prentice Hall Publications.
- 4. Introduction to VLSI circuits and Systems- John Uyemura- John Wiley and sons.
- 5. CMOS Digital Integrated Circuits SungMo Kang, Yusuf Leblebici Tata McGraw Hill Publications.

Course Code: EN705/ ET 705 Elective-I (iv)

Title of the Course: Elective-I: Biomedical Engineering

Course Scheme				Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	actical Periods/ Credits		Duration of paper (in hrs) MSE IE ESE			Total	
3	1	0	4	4	3	10	10	80	100

Units	Contents	Hours
	Physiological Systems and signals:	
1	Physiological Systems of the Body - Cardiovascular System, The Respiratory System,	0
1	The Nervous System, Basic Medical Instrumentation System, Origin of Biomedical	9
	Signals, Basics and Waveforms of Bioelectric Signals like ECG, EEG and EMG.	
	Physiological Transducer:	0
2	Displacement, Position and Motion Transducers, Pressure Transducers, Transducers	9
	for body temperature measurement, photoelectric.	
	Biomedical Recorders:	0
3	Basic working and block diagram of biomedical recorders - Electrocardiograph,	9
	Phonocardiograph, Electroencephalograph and Electromyography.	
	Patient Monitoring Systems:	
	System Concept, Cardiac Monitor, Bedside Patient Monitoring Systems, Central	
	Monitors, Measurement of heart rate, Measurement of pulse rate, Blood pressure	0
4	measurement, Measurement of respiration rate.	9
	Patient Safety:	
	Electric Shock Hazards, Leakage Currents, Safety code for Electrical Equipment,	
	Electrical Safety Analyzers, Testing of Biomedical Equipments.	
	Imaging Techniques:	
	X Ray: Production of X Ray, X-Ray Machines.	0
5	CT-Scanning : Basic principle of X-Ray Computed Tomography, System Components	9
	of CT Scan, MRI: Nuclear Magnetic Resonance (NMR) basic components.	
	Ultra Sound: Ultrasonic basic pulse-echo apparatus.	
	Total	45

- 1. Khandpur R. S., "Handbook of Biomedical Instrumentation", Tata McGraw Hill, second edition, 2003.
- 2. Carr and Brown, "Introduction to biomedical equipment technology", 4th edition, Pearson press, 2003.
- 3. W. R. Hendee & E. R. Ritenour, "Medical Imaging Physics", 3rd edition, Mosbey Year-Book, inc. 1992.

- 1. John G. Webster, Bioinstrumentation John Wiley and sons, 2004 2. Joseph Bronzino (Editor-in-Chief), Handbook of Biomedical Engineering, CRC Press, 1995.
- 2. Neelina Malsch, Biomedical nanotechnology by CRC press release, Malsch echnoValuation, Utrecht, The Netherlands.
- 3. Khandpur R S, Handbook of Analytical Instrumentation, Tata McGraw Hill
- 4. Harold E. Smalley, "Hospital Management Engineering A guide to the improvement of hospital management system", PHI. C. A. Caceras ,"Clinical Engineering" Inc., 1992
- 5. Sujata V. Bhat, "Biomaterials", Narosa Publishing House, 2002.

Course Code: EN 705/ET705 Elective –I (v) **Title of the Course:** Elective –I: Device Modeling

Course Scheme				Evaluation Scheme (Theory)					
Lecture	Tutorial	Practical	Periods/ week	Credits	Duration of paper (in hrs)	MSE	IE	ESE	Total
3	1	0	4	4	3	10	10	80	100

Units	Contents	Hours
1	Introduction to SPICE Simulation : Circuit Descriptions, DC circuit analysis, modeling of dc sources, AC circuit analysis, modeling of ac sources, transient analysis, modeling of transient sources.	9
2	p-n junction- concepts and models : The p-n junction, contact potential, Depletion width, carrier injection, Diode I-V characteristic, junction capacitance, SPICE model for diode.	9
3	Bipolar transistors and models: Amplification with BJT, Minority carrier distributions and terminal currents, Switching cycle, Ebers-Moll equations, The coupled diode model, Basic SPICE Models, Small-signal model.	9
4	MOS transistors: Threshold voltage, Current-voltage characteristics, Subthreshold conduction, Hot electron effects, Drain induced barrier lowering Short channel effect and narrow width effect.	9
5	MOS modeling: MOS model in SPICE, Level 1 device model, BSIM3 model, mobility model, MOS inverter circuits, voltage transfer characteristics, Noise margin.	9
	Total	45

- 1. "Solid State Electronic Devices", "B. G. Streetman and S. Banerjee", Prentice Hall India
- 2. "Analysis and Design of Digital Integrated circuits", "D. A. Hodges, and H. G. Jackson", McGraw-Hill International.
- 3. "SPICE for circuits and electronics using PSPICE", "Muhammad H. Rashid", Prentice Hall India
- 4. "Introduction to VLSI circuit and systems", "J. P. Uyemura", John Wiley and Sons

Course Code: ET706

Title of the Course: UHF & Microwave (Practical)

	C	Course Schem	Evaluatio	n Scheme(La	boratory)		
Lecture	Tutorial	Practical	Periods/ week	Credits	TW	POE	Total
0	0	3	3	3	25	25	50

Minimum 8 experiments from list below or experiment based on syllabus.

List of suggested experiments						
1.	To study propagation of microwaves.					
2.	Study of primary antennas.					
3.	Measurement of microwaves power					
4.	Measurement of frequency and wavelength					
5.	Measurement of VSWR.					
6.	Measurement of Impedance.					
7.	To study characteristics of E-plane and H-plane tee.					
8.	To study the characteristics of magic tee.					
9.	Study of Directional Couplers.					
10.	Study of ferrite devices					
11.	Find the Reflection loss within a wave guide.					
12.	To study the characteristics of Reflex Klystron.					

Course Code: ET707 **Title of the Course:** Digital communication (Practical)

	0	Course Schem	Evaluatio	n Scheme(La	boratory)		
Lecture	Tutorial	Practical	Periods/ week	Credits	TW	POE	Total
0	0	3	3	2	25	25	50

It includes at least 7-8 experiments based on the theory syllabus of Digital communication.

	List of suggested experiments
1.	Comparisons of frequency response of second order and fourth order Butterworth low pass filter
2.	Pulse code modulation and demodulation
3.	Delta modulation and demodulation
4.	Adaptive Delta modulation and demodulation
5.	Phase shift keying
6.	Amplitude shift keying
7.	Quadrature phase shift keying
8.	Frequency shift keying

Course Code: ET708

Title of the Course: Opto-electronics devices and communication (Practical)

	C	Course Schem	Evaluatio	n Scheme(La	boratory)		
Lecture	Tutorial	Practical	Periods/ week	Credits	TW	POE	Total
0	0	3	3	2	25	25	50

Minimum 8 Practical based on the prescribed syllabus.

Course Code: ET709 **Title of the Course:** Major Project Phase –I (Practical)

	C	Course Schem	Evaluation Scheme(Laboratory)				
Lecture	Tutorial	Practical	Periods/ week	Credits	TW	POE	Total
0	0	3	3	2	50	00	50

- The Major Project Phase–I It includes seminar work, literature survey and minimal implementation of the project including software and Hardware, which is to be carried out in the institution/industry/research laboratory.
- The duration of project work should be a minimum of two semesters: Major Project Phase –I & II.
- Each student has to present a seminar, on any technical topic related to any subject not covered in the syllabus or preferably based on the project.
- The presentation time is of minimum 10 minutes followed by a 5 minutes session for discussion/question and answers.
- The seminar topic selected by the student must be approved by the project committee of the department at the beginning of the semester; the duplicity of the topics must be avoided.
- Each student/project group has to demonstrate the minimal implementation of the project work and should submit individual seminar report on the day of seminar to the department along with the project progress report.
- The seminar presentation & submission of the report will carry 50% weightage and demonstration and submission of project progress report will carry 50% weightage for final evaluation. The evaluation is to be carried out by department project committee including guide.